

GR-04E001UG: E-mode GaN Power Transistor

Description

GR-04E001UG is an enhancement mode GaN on Silicon power transistor. GR-04E001UG provides, high current and high operating speed which is suitable for DC to DC power supply applications.

Key Specifications

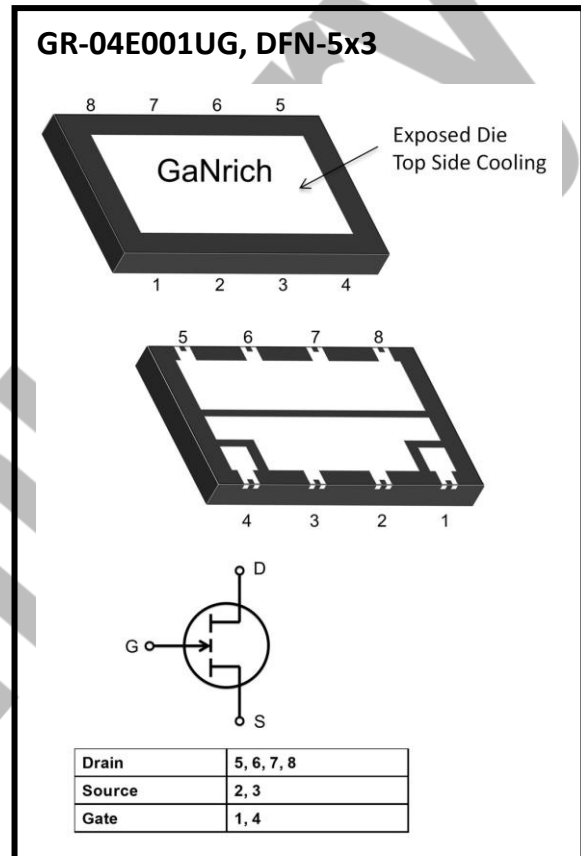
| | |
|---|-------------|
| Part Number | GR-04E001UG |
| V _{DSS} , min. | 40V |
| I _{DS} , Pulse (25°C, TPULSE = 300 μs) | 304A |
| R _{DS(ON)} , typ. @V _{gs} =5V | 1.2mΩ |
| Q _G , typ. | 17.1nC |

Features

- 40V enhancement mode power transistor
- High operating frequency
- R_{DS(on)} = Typ. 1.2 mΩ
- Dual-side cooled package
- HS compliant

Applications

- Switch Mode Power Supplies (SMPS)
- DC-DC Converters
- Fast Battery Charging
- Appliance Motor Drives



1. Electrical Characteristics

➤ **Table 1 Absolute maximum ratings**

| Symbol | Parameter | Value | Unit |
|---------------|---|-------------|------------------|
| V_{DSS} | Drain-source voltage | 40 | V |
| $V_{(TR)DSS}$ | Transient drain to source voltage ^a | 48 | V |
| V_{GSS} | Gate- source voltage | -6V ~ +6V | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ operation | 97 | A |
| | Drain current (continuous) at $T_C = 100^\circ\text{C}$ operation | 66 | A |
| $I_{D,Pulse}$ | Pulsed drain current (pulse width: $300\mu\text{s}$, $V_{GS}=5\text{V}$) ^b | 304 | A |
| T_J | Operating temperature | -40 to +150 | $^\circ\text{C}$ |
| T_S | Storage temperature | -40 to +150 | $^\circ\text{C}$ |

- a. In off-state, spike duty cycle $D < 0.01$, spike duration $< 1\mu\text{s}$
 b. Defined by product design and characterization. Value is not tested to full current in production

➤ **Table 2 Thermal Characteristics**

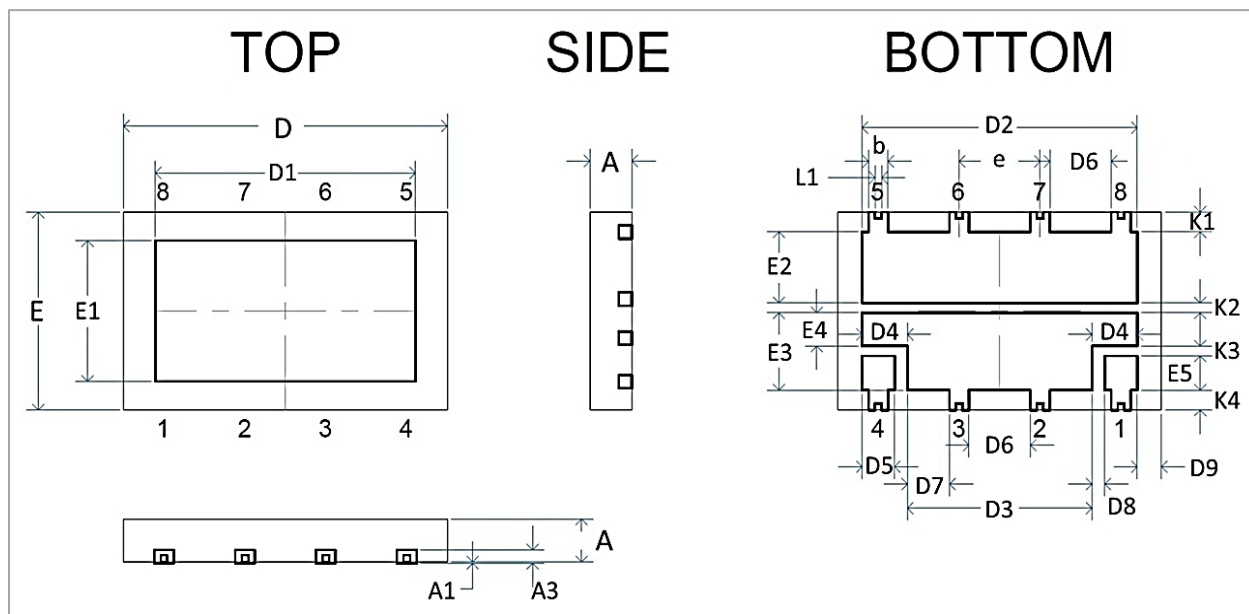
| Symbol | Parameter | Value | Unit |
|----------------------|--|-------|---------------------------|
| $R_{\theta JC_Top}$ | Thermal resistance junction-case, Top | 0.50 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC_Bot}$ | Thermal resistance junction-case, Bottom | 0.50 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal resistance junction-ambient | 60 | $^\circ\text{C}/\text{W}$ |

- a. Tested in package DFN 5x3.

➤ **Table 3** Electrical Characteristics ($T_{CASE} = 25\text{ }^{\circ}\text{C}$ unless otherwise stated)

| Symbol | Parameter | Conditions | Values | | | Unit |
|--------------|--|---|--------|------|------|------------|
| | | | min. | typ. | max. | |
| V_{DSS} | Drain-source voltage | $V_{GS} = 0V, I_D = 250\mu A$ | 40 | - | - | V |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 1mA$ | 0.8 | 1.1 | 1.6 | V |
| $R_{DS(on)}$ | Static drain-source on-resistance | $V_{GS} = 6V, I_D = 20A$ | - | 1.2 | 1.6 | m Ω |
| I_{DSS} | Drain-source leakage current | $V_{DS} = 32V, V_{GS} = 0V$ | - | 5.0 | 400 | μA |
| I_{GSS} | Gate-to-Source Forward Leakage current | $V_{GS} = +5V, T_J = 25^{\circ}\text{C}$ | - | 0.1 | 20 | mA |
| | Gate-to-Source Forward Leakage current | $V_{GS} = +5V, T_J = 125^{\circ}\text{C}$ | - | 0.95 | 28.4 | mA |
| | Gate-to-Source Reverse Leakage current | $V_{GS} = -4V, T_J = 25^{\circ}\text{C}$ | - | 0.09 | 2.8 | mA |
| C_{ISS} | Input capacitance | $V_{DS} = 20V, V_{GS} = 0V$ | - | 1392 | - | pF |
| C_{OSS} | Output capacitance | | - | 578 | - | |
| C_{RSS} | Reverse transfer capacitance | | - | 50 | - | |
| Q_G | Gate charge | $V_{DS} = 20V, V_{GS} = 5V, I_D = 20A$ | - | 17.1 | - | nC |
| Q_{GS} | Gate-source charge | $V_{DS} = 20V, I_D = 20A$ | - | 6.4 | - | |
| Q_{GD} | Gate-drain charge | | - | 2.9 | - | |
| Q_{OSS} | Output charge | $V_{DS} = 20V, V_{GS} = 0V$ | - | 39.5 | - | |
| Q_{RR} | Reverse recovery charge | - | - | 0 | - | |

3. Package Outline Dimensions



➤ Table 4 Dimension of GR-DFN-5x3

| SYMBOL | DIMENSION (MM) | | | SYMBOL | DIMENSION (IN MM) | | |
|--------|----------------|------|------|--------|-------------------|-------|-------|
| | MIN. | NOM. | MAX. | | MIN. | NOM. | MAX. |
| A | 0.60 | 0.65 | 0.70 | D7 | 0.55 | 0.65 | 0.75 |
| A2 | -- | 0.02 | 0.05 | D8 | 0.10 | 0.20 | 0.30 |
| A3 | 0.203 REF | | | D9 | 0.365 | 0.375 | 0.385 |
| D | 4.90 | 5.00 | 5.10 | E1 | 2.132 REF | | |
| E | 2.90 | 3.00 | 3.10 | E2 | 0.976 | 1.076 | 1.176 |
| e | 1.25 BSC | | | E3 | 1.074 | 1.174 | 1.274 |
| b | 0.20 | 0.30 | 0.40 | E4 | 0.405 | 0.505 | 0.605 |
| D1 | 4.018 REF | | | E5 | 0.419 | 0.519 | 0.619 |
| D2 | 4.15 | 4.25 | 4.35 | K1 | 0.20 | 0.30 | 0.40 |
| D3 | 2.75 | 2.85 | 2.95 | K2 | 0.05 | 0.15 | 0.25 |
| D4 | 0.60 | 0.70 | 0.80 | K3 | 0.05 | 0.15 | 0.25 |
| D5 | 0.40 | 0.50 | 0.60 | K4 | 0.20 | 0.30 | 0.40 |
| D6 | 0.85 | 0.95 | 1.05 | | | | |

5. Change Log

| Version | Date | Description |
|---------|------------------|------------------------------------|
| 0.1 | January 12, 2026 | Initial version |
| 0.2 | April 16, 2026 | Electrical characteristics revised |

- **Note:** GaNrich semiconductor reserves the right to revise products and/or specifications without notice.